High Reliability Hermetic Infrared Emitting Diode



OP235 (TX, TXV) OP236 (TX, TXV)

Features:

- TO-46 hermetically sealed package with lens
- Twice the power output of GaAs at same drive current
- Characterized to define infrared energy along mechanical axis of device
- Narrow beam angle
- Processed to MIL-PRF-19500



Description:

Each device in this series is a gallium aluminum arsenide (GaAlAs) infrared emitting diode, mounted in a hermetic metal TO-46 housing with 0.50" (12.70 mm) minimum length leads. The gallium aluminum arsenide feature provides a higher radiated output than gallium arsenide at the same forward current, while the 890 nm wavelength closely matches the spectral response of silicon phototransistors. Devices have lens cans that provide an 18° beam angle between half power points, which facilitates the easy design of beam interrupt applications with the OP804 and OP805 series of high reliability phototransistors.

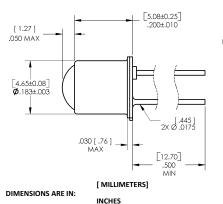
TX and TXV devices are processed to OPTEK's military screening program patterned after MIL-PRF-19500. After 100 % screening, Group A and B are performed on every lot and a Group C test is performed every six months.

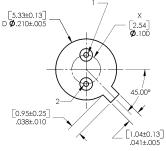
Please refer to Application Bulletins 208 and 210 for additional design information and reliability (degradation) data.

Applications:

- Non-contact reflective object sensor
- Assembly line automation
- Machine automation
- Machine safety
- End of travel sensor
- Door sensor
- Military and harsh environments

Part Number	LED Peak Wavelength	Output Power (mW/cm²) Min / Max	I _F (mA) Typ / Max	Total Beam Angle	Lead Length (Min)
OP235TX		1.5 / NA		18°	0.50"
OP235TXV	890 nm	1.5 / NA	50 / 100		
OP236TX	050 11111	3.5 / NA	30 / 100		
OP236TXV		5.5 / NA			







Pin#	LED		
1	Anode		
2	Cathode		

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Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

Storage Temperature Range	-65° C to +150° C
Operating Temperature Range	-55° C to +125° C
Reverse Voltage	2.0 V
Forward DC Current	100 mA
Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 seconds with soldering iron] (1)	260° C
Power Dissipation ⁽²⁾	200 mW

Electrical Characteristics (T_A = 25° C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS
E _{E(APT)} ⁽³⁾	Apertured Radiant Incidence OP235 (TX, TXV) OP236 (TX, TXV)	1.5 3.5	-		mW/cm²	I _F = 100 mA
V _F	Forward Voltage	1.1 1.3 0.9	1 1 1	2.0 2.2 1.8	V	I _F = 100 mA I _F = 100 mA, T _A = -55° C I _F = 100 mA, T _A = 100° C
I _R	Reverse Current	-	ı	100	μΑ	V _R = 2.0 V
λ_{P}	Wavelength at Peak Emission	-	890	-	nm	I _F = 100 mA
β	Spectral Bandwidth between Half Power Points	-	50	ı	nm	I _F = 100 mA
θ_{HP}	Emission Angle at Half Power Points	-	18	-	Degree	I _F = 100 mA

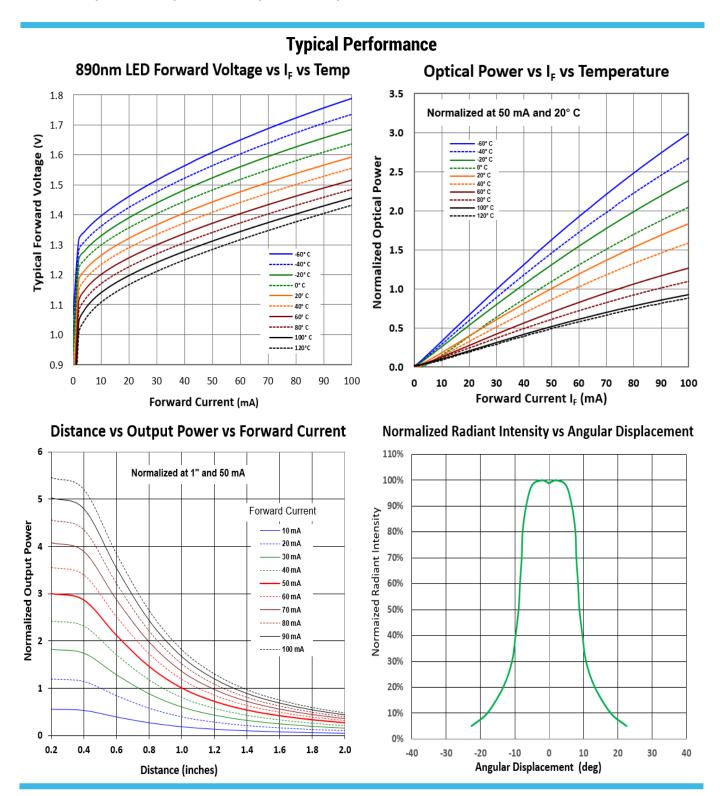
Notes:

- 1. RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.
- 2. Derate linearly 1.80 mW/° C above 25° C.
- 3. E_{E(APT)} is a measurement of the average radiant intensity within the cone formed by the measurement surface, a radius of 1.429" (36.30 mm) measured from the lens side of the tab to the sensing surface and a sensing surface of 0.250" (6.35 mm) in diameter forming a 10° cone. E_{E(APT)} is not necessarily uniform within the measured area.

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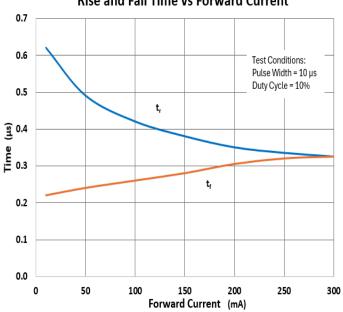
High Reliability Hermetic Infrared Emitting Diode



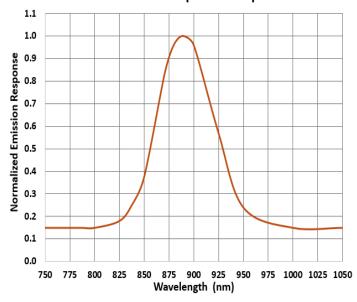
OP235 (TX, TXV) OP236 (TX, TXV)

Typical Performance

Rise and Fall Time vs Forward Current



GaAlAs LED Spectral Output



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

TT Electronics:

OP236TX OP235TX OP236TXV